



NPN SILICON GERMANIUM RF TRANSISTOR

NESG2101M16

NPN SiGe RF TRANSISTOR FOR MEDIUM OUTPUT POWER AMPLIFICATION (125 mW) 6-PIN LEAD-LESS MINIMOLD (M16, 1208 PKG)

FEATURES

- The device is an ideal choice for medium output power, high-gain amplification and low distortion, low noise, high-gain amplification
 $P_{O(1\text{ dB})} = 21\text{ dBm TYP. @ } V_{CE} = 3.6\text{ V, } I_c(\text{set}) = 10\text{ mA (RF OFF), } f = 2\text{ GHz}$
 $NF = 0.6\text{ dB TYP., } G_a = 19.0\text{ dB TYP. @ } V_{CE} = 2\text{ V, } I_c = 7\text{ mA, } f = 1\text{ GHz}$
- Maximum stable power gain: $MSG = 17.0\text{ dB TYP. @ } V_{CE} = 3\text{ V, } I_c = 50\text{ mA, } f = 2\text{ GHz}$
- High breakdown voltage technology for SiGe Tr. adopted: V_{CEO} (absolute maximum ratings) = 5.0 V
- 6-pin lead-less minimold (M16, 1208 PKG)

<R> ORDERING INFORMATION

Part Number	Order Number	Package	Quantity	Supplying Form
NESG2101M16	NESG2101M16-A	6-pin lead-less minimold (M16, 1208 PKG) (Pb-Free)	50 pcs (Non reel)	<ul style="list-style-type: none"> 8 mm wide embossed taping Pin 1 (Collector), Pin 6 (Emitter) face the perforation side of the tape
NESG2101M16-T3	NESG2101M16-T3-A		10 kpcs/reel	

Remark To order evaluation samples, please contact your nearby sales office.
Unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS ($T_A = +25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	V_{CBO}	13.0	V
Collector to Emitter Voltage	V_{CEO}	5.0	V
Emitter to Base Voltage	V_{EBO}	1.5	V
Collector Current	I_c	100	mA
Total Power Dissipation	P_{tot} ^{Note}	190	mW
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +150	$^\circ\text{C}$

Note Mounted on $1.08\text{ cm}^2 \times 1.0\text{ mm (t)}$ glass epoxy PCB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

ELECTRICAL CHARACTERISTICS (T_A = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	I _{CBO}	V _{CB} = 5 V, I _E = 0 mA	–	–	100	nA
Emitter Cut-off Current	I _{EBO}	V _{EB} = 1 V, I _C = 0 mA	–	–	100	nA
DC Current Gain	h _{FE} ^{Note 1}	V _{CE} = 2 V, I _C = 15 mA	130	190	260	–
RF Characteristics						
Gain Bandwidth Product	f _T	V _{CE} = 3 V, I _C = 50 mA, f = 2 GHz	14	17	–	GHz
Insertion Power Gain	S _{21e} ²	V _{CE} = 3 V, I _C = 50 mA, f = 2 GHz	11.5	13.5	–	dB
Noise Figure (1)	NF	V _{CE} = 2 V, I _C = 10 mA, f = 2 GHz, Z _S = Z _{Sopt} , Z _L = Z _{Lopt}	–	0.9	1.2	dB
Noise Figure (2)	NF	V _{CE} = 2 V, I _C = 7 mA, f = 1 GHz, Z _S = Z _{Sopt} , Z _L = Z _{Lopt}	–	0.6	–	dB
Associated Gain (1)	G _a	V _{CE} = 2 V, I _C = 10 mA, f = 2 GHz, Z _S = Z _{Sopt} , Z _L = Z _{Lopt}	11.0	13.0	–	dB
Associated Gain (2)	G _a	V _{CE} = 2 V, I _C = 7 mA, f = 1 GHz, Z _S = Z _{Sopt} , Z _L = Z _{Lopt}	–	19.0	–	dB
Reverse Transfer Capacitance	C _{re} ^{Note 2}	V _{CB} = 2 V, I _E = 0 mA, f = 1 MHz	–	0.4	0.5	pF
Maximum Stable Power Gain	MSG ^{Note 3}	V _{CE} = 3 V, I _C = 50 mA, f = 2 GHz	14.5	17.0	–	dB
Gain 1 dB Compression Output Power	P _{O(1 dB)}	V _{CE} = 3.6 V, I _{C(set)} = 10 mA (RF OFF), f = 2 GHz, Z _S = Z _{Sopt} , Z _L = Z _{Lopt}	–	21	–	dBm
Linear Gain	G _L	V _{CE} = 3.6 V, I _C = 10 mA, f = 2 GHz, Z _S = Z _{Sopt} , Z _L = Z _{Lopt}	–	15	–	dBm

Notes 1. Pulse measurement: PW ≤ 350 μs, Duty Cycle ≤ 2%

2. Collector to base capacitance when the emitter grounded

$$3. \text{MSG} = \left| \frac{S_{21}}{S_{12}} \right|$$

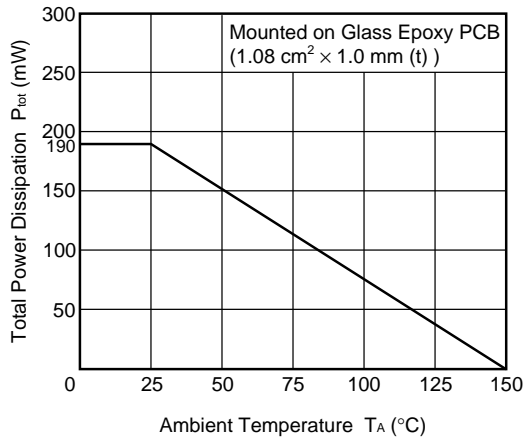
h_{FE} CLASSIFICATION

<R>

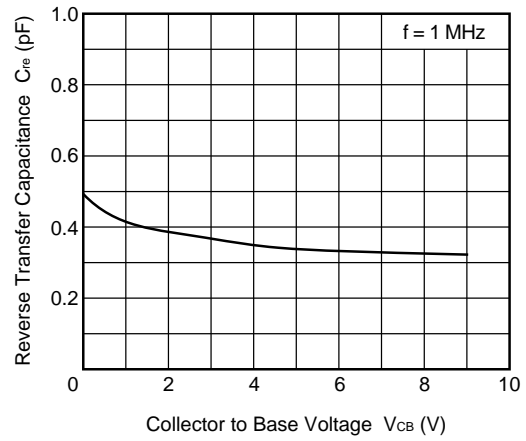
Rank	FB/YFB
Marking	zH
h _{FE} Value	130 to 260

<R> TYPICAL CHARACTERISTICS (T_A = +25°C, unless otherwise specified)

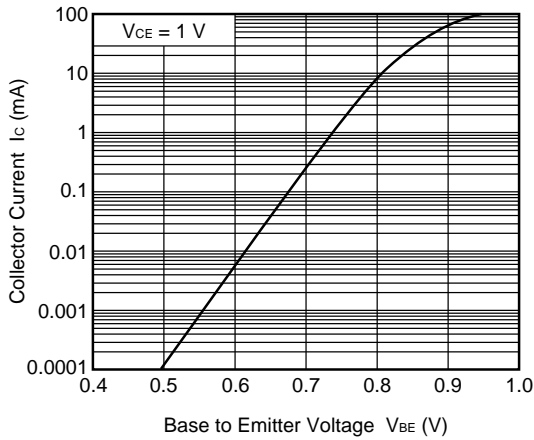
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



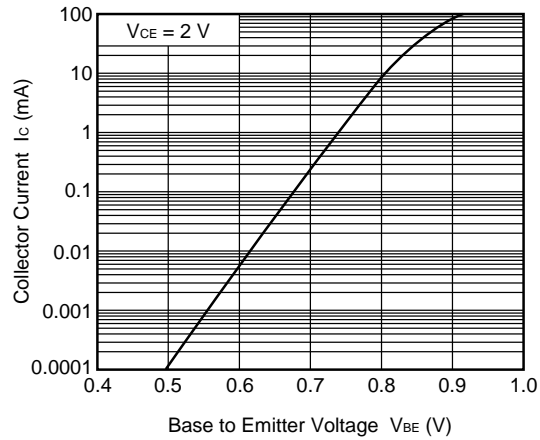
REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE



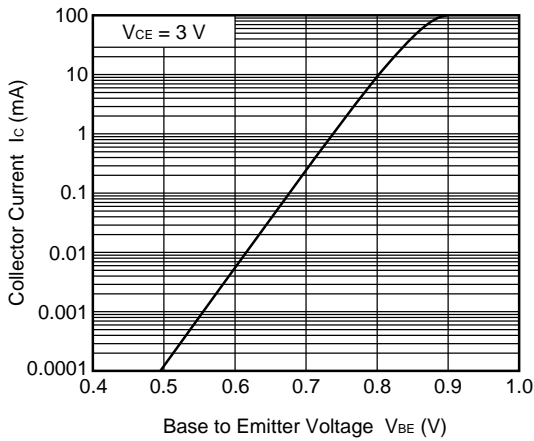
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



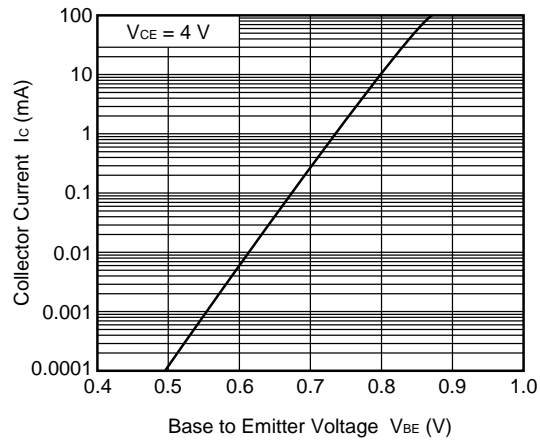
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE

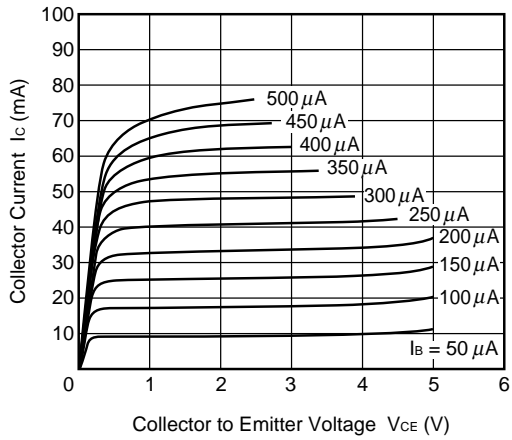


COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE

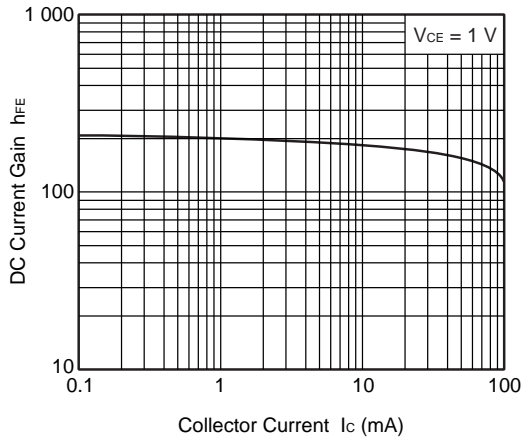


Remark The graphs indicate nominal characteristics.

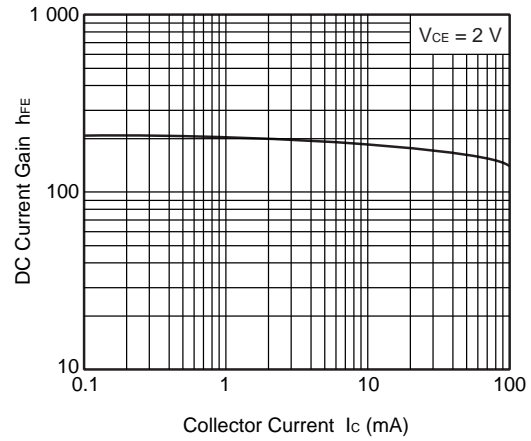
COLLECTOR CURRENT vs.
COLLECTOR TO EMITTER VOLTAGE



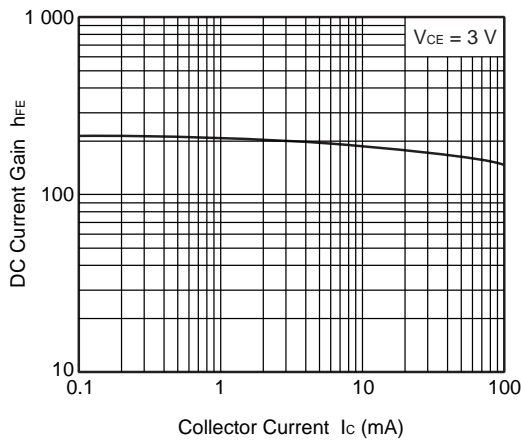
DC CURRENT GAIN vs.
COLLECTOR CURRENT



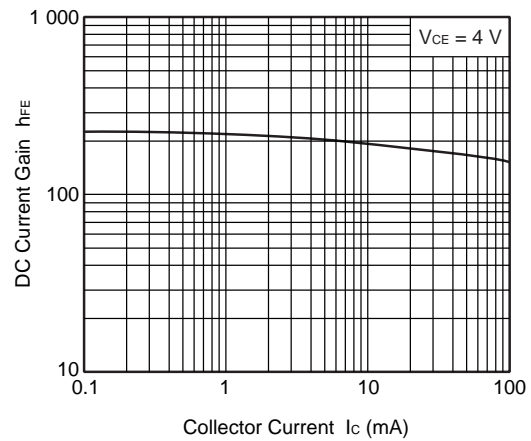
DC CURRENT GAIN vs.
COLLECTOR CURRENT



DC CURRENT GAIN vs.
COLLECTOR CURRENT

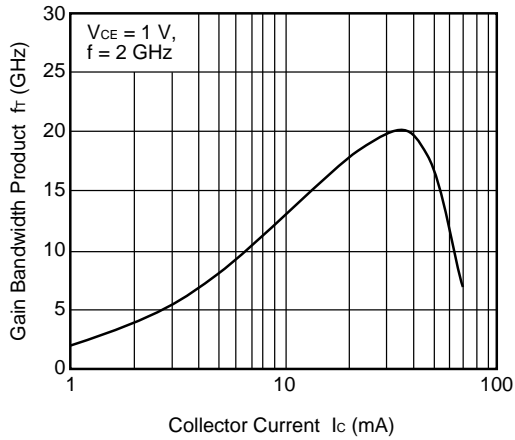


DC CURRENT GAIN vs.
COLLECTOR CURRENT

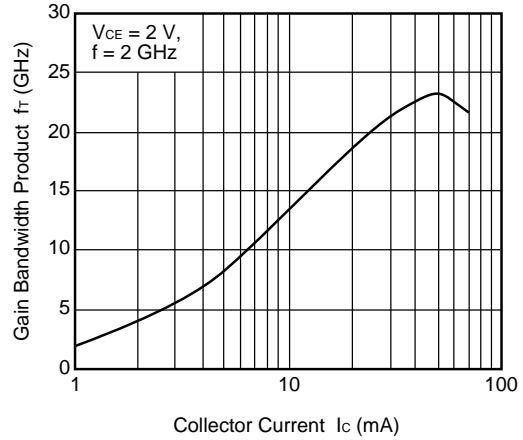


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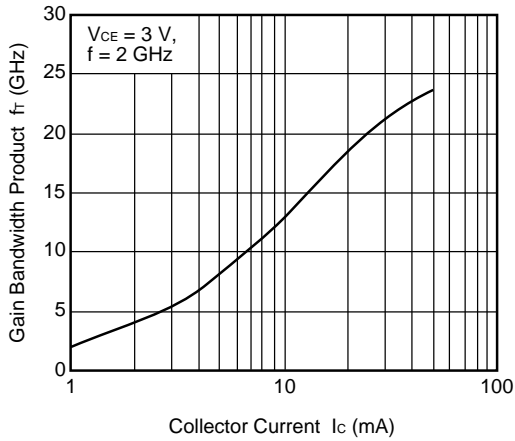
GAIN BANDWIDTH PRODUCT
vs. COLLECTOR CURRENT



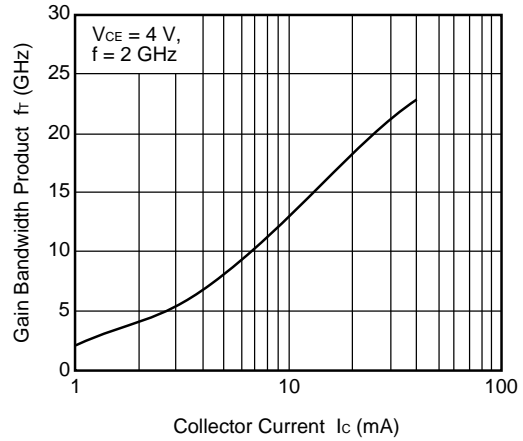
GAIN BANDWIDTH PRODUCT
vs. COLLECTOR CURRENT



GAIN BANDWIDTH PRODUCT
vs. COLLECTOR CURRENT

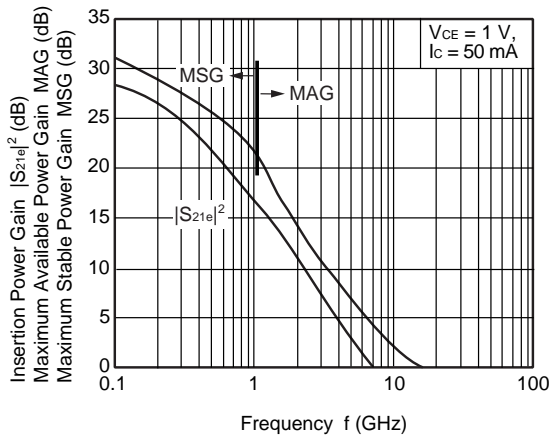


GAIN BANDWIDTH PRODUCT
vs. COLLECTOR CURRENT

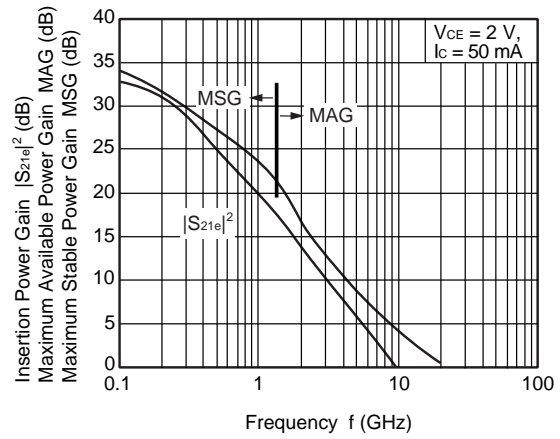


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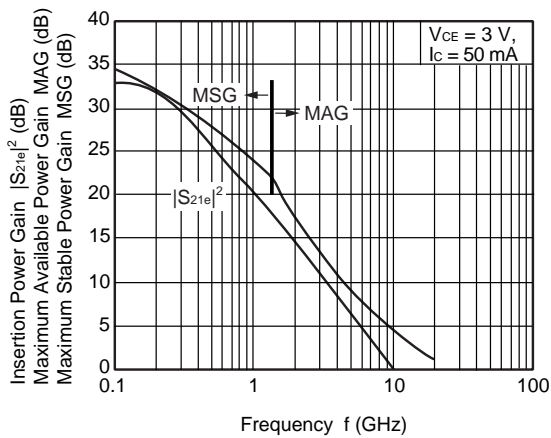
INSERTION POWER GAIN, MAG, MSG vs. FREQUENCY



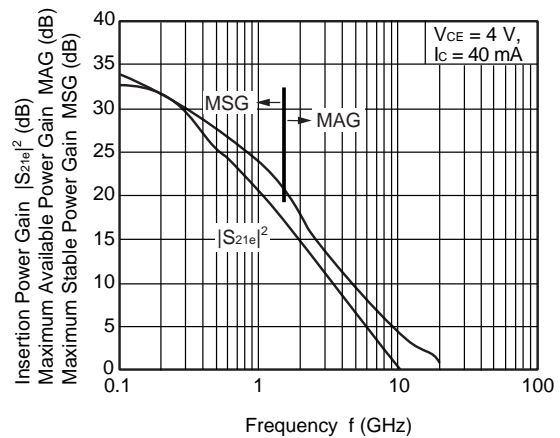
INSERTION POWER GAIN, MAG, MSG vs. FREQUENCY



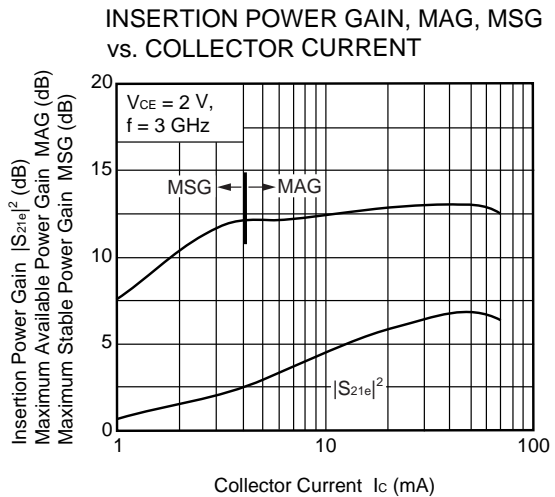
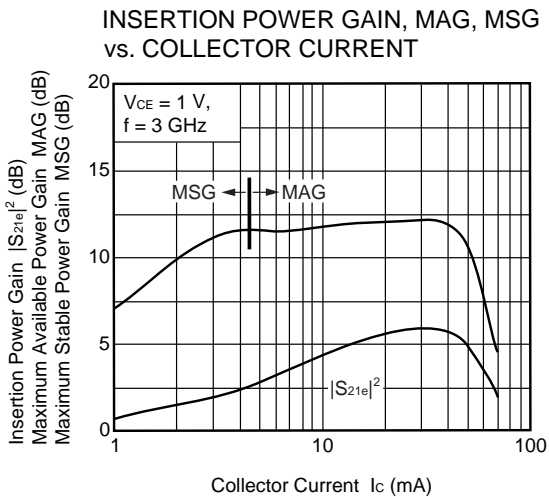
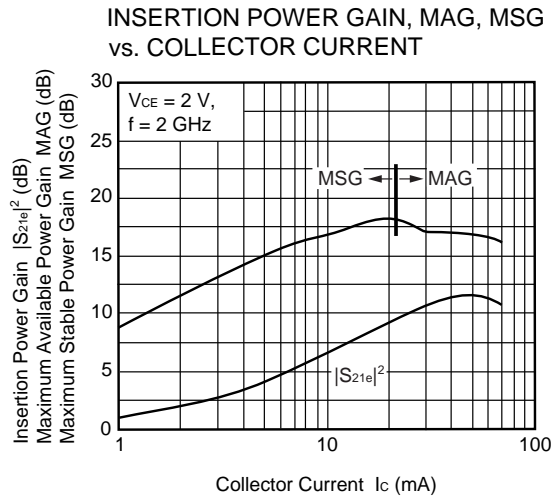
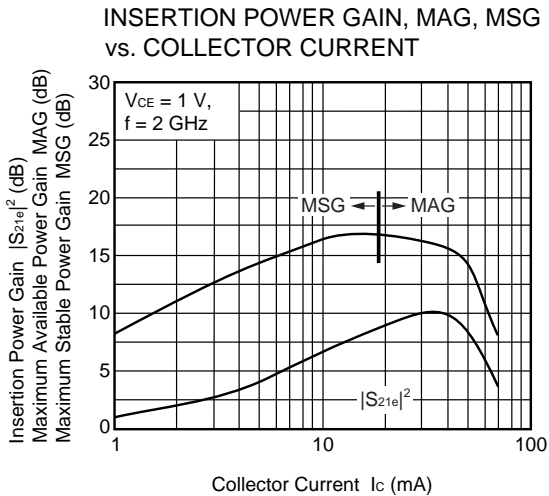
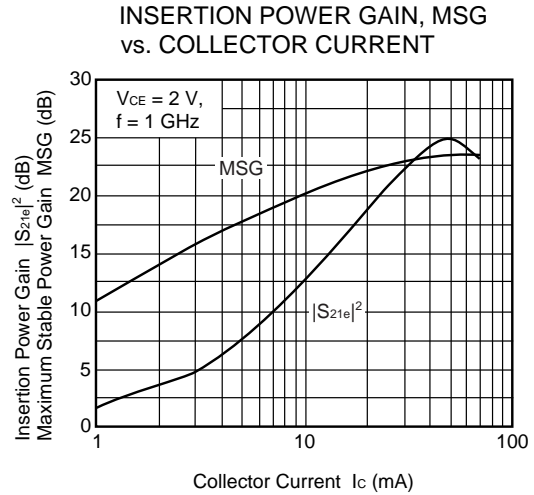
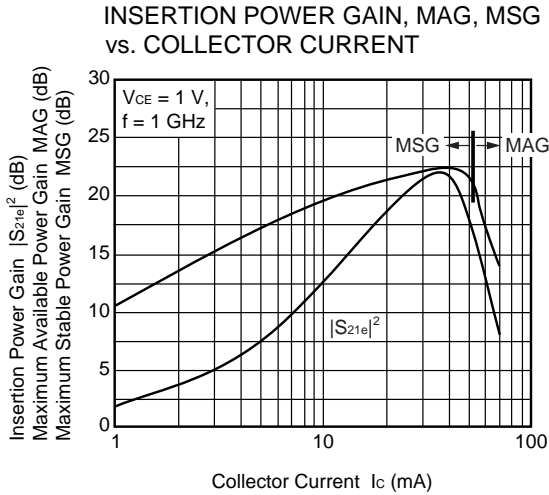
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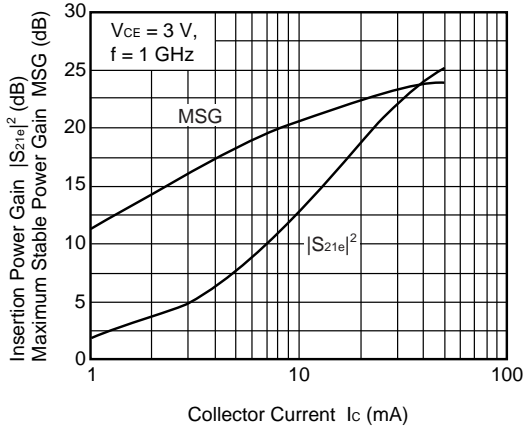


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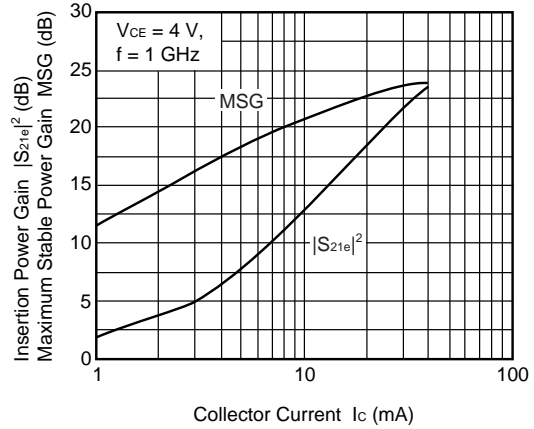


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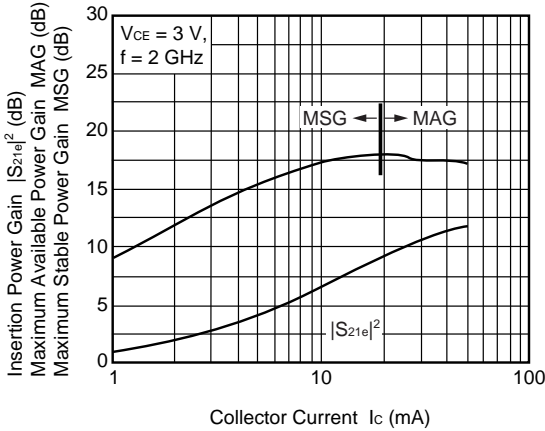
INSERTION POWER GAIN, MSG vs. COLLECTOR CURRENT



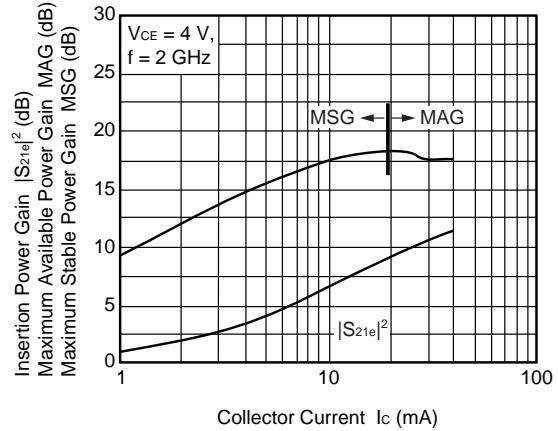
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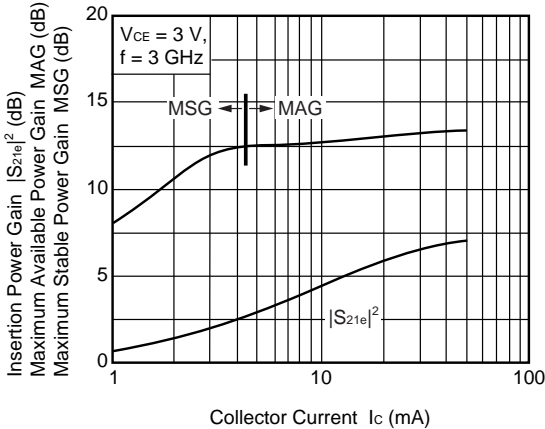
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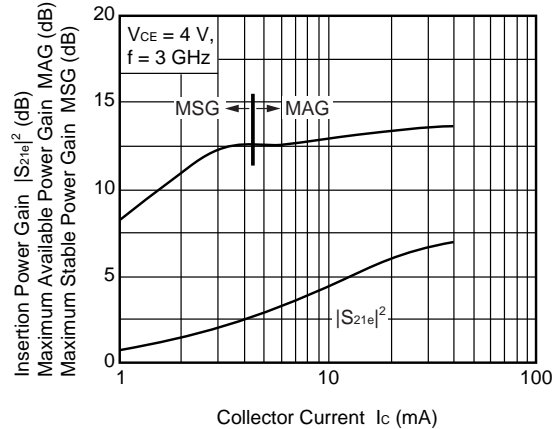
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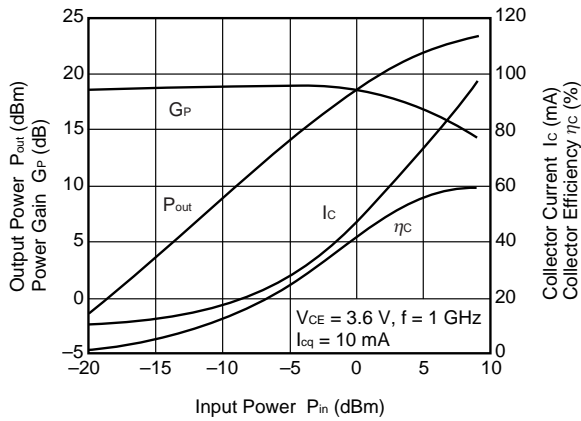


INSERTION POWER GAIN, MAG, MSG vs. COLLECTOR CURRENT

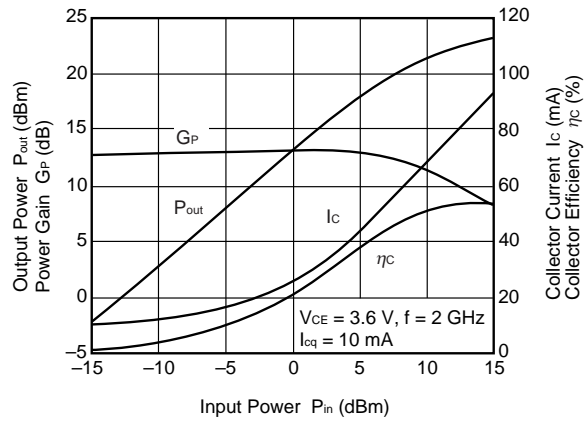


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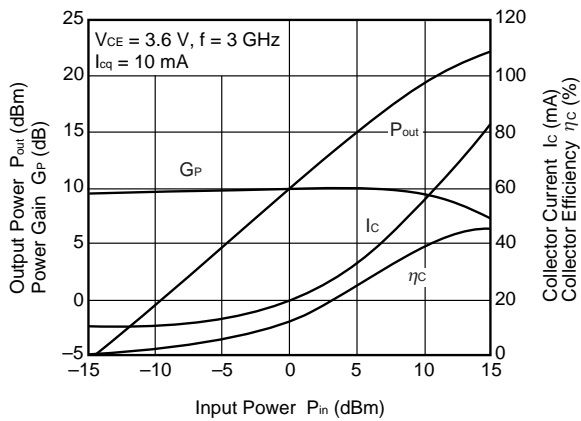
OUTPUT POWER, POWER GAIN, I_c ,
COLLECTOR EFFICIENCY vs. INPUT POWER



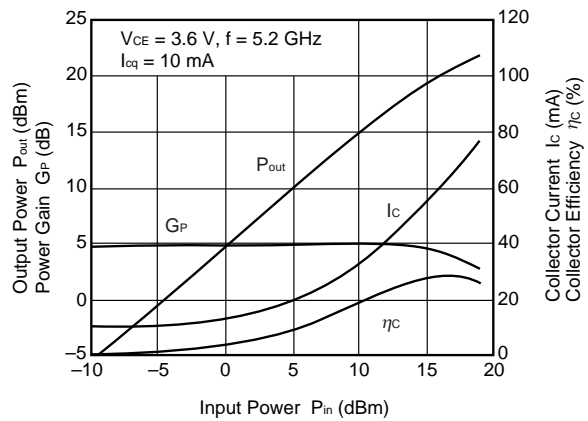
OUTPUT POWER, POWER GAIN, I_c ,
COLLECTOR EFFICIENCY vs. INPUT POWER



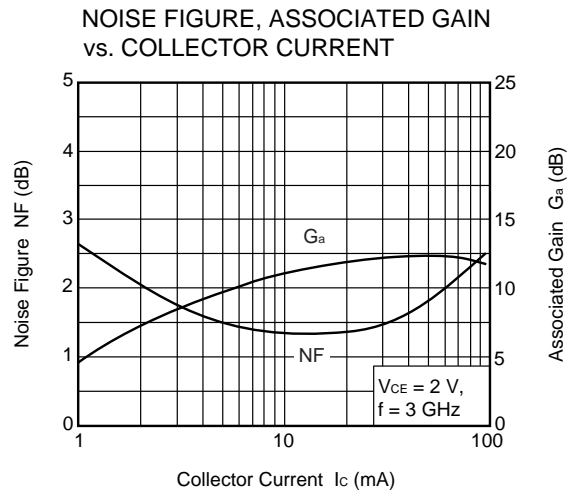
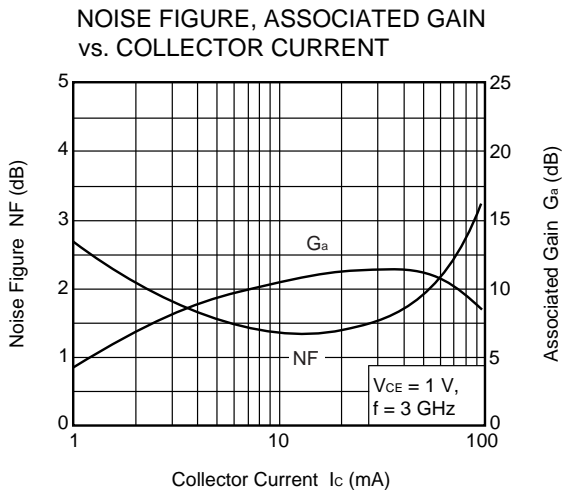
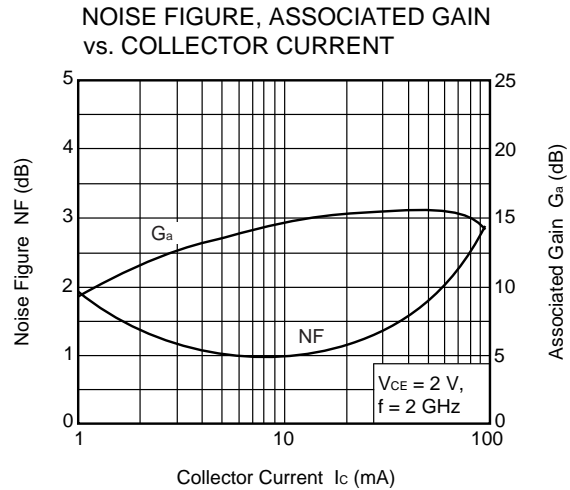
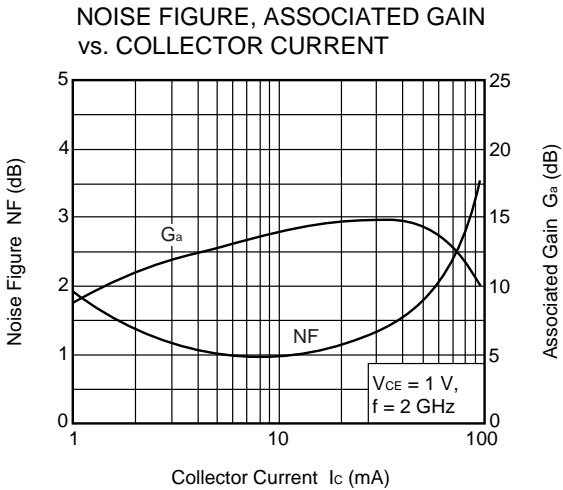
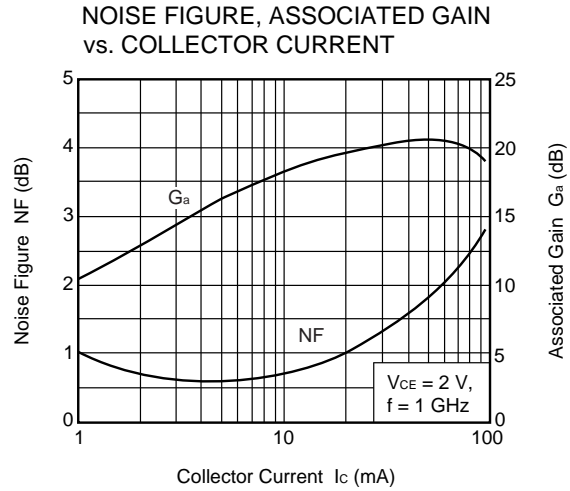
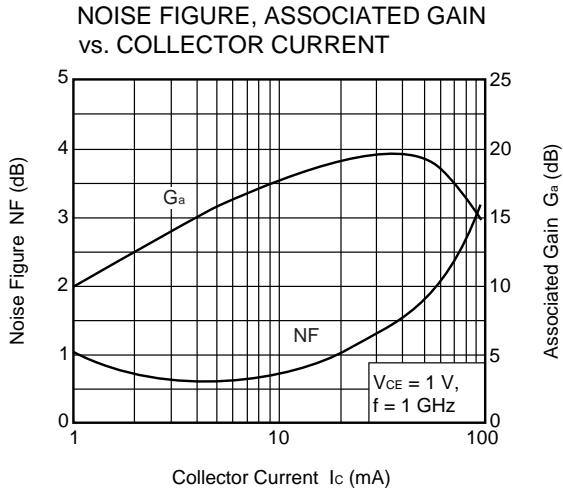
OUTPUT POWER, POWER GAIN, I_c ,
COLLECTOR EFFICIENCY vs. INPUT POWER



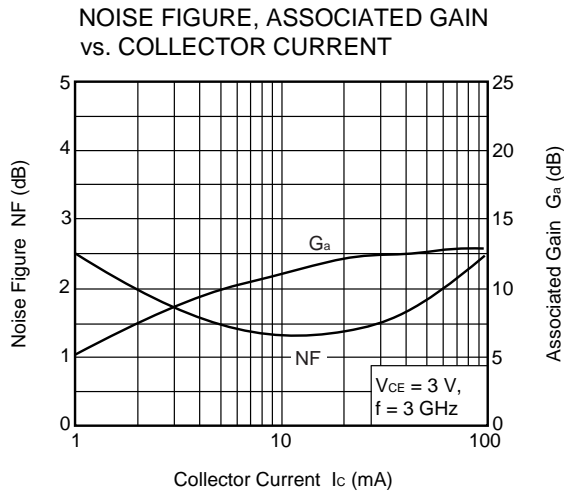
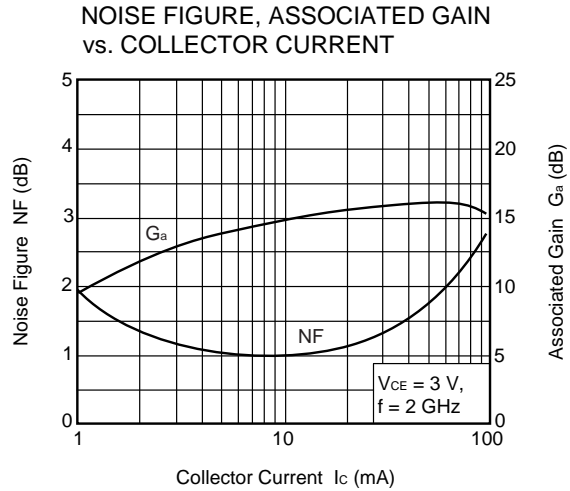
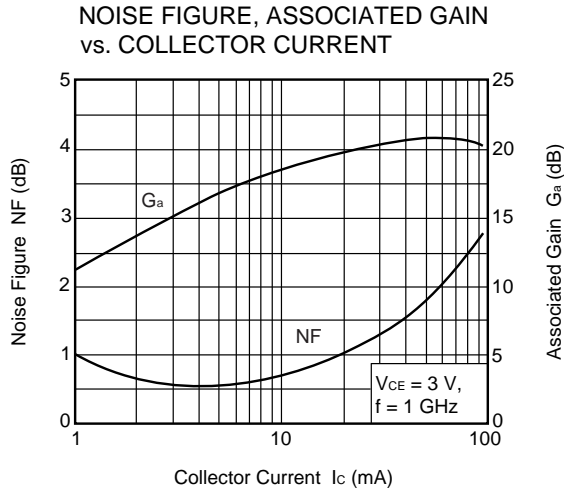
OUTPUT POWER, POWER GAIN, I_c ,
COLLECTOR EFFICIENCY vs. INPUT POWER



Remark The graphs indicate nominal characteristics.



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<R> **S-PARAMETERS**

S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.

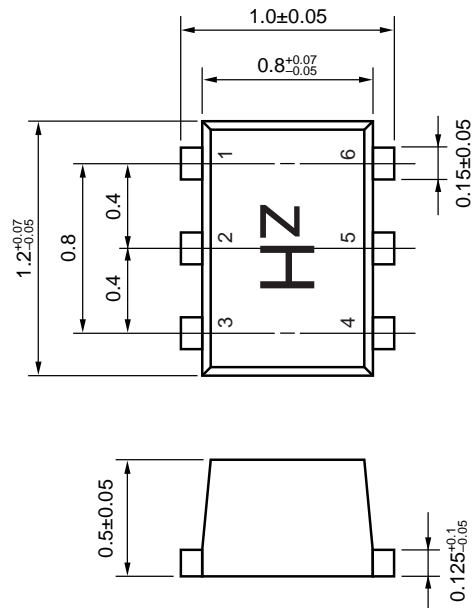
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

URL <http://www.necel.com/microwave/en/>

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (M16, 1208 PKG) (UNIT: mm)



PIN CONNECTIONS

1. Collector
2. Emitter
3. Emitter
4. Base
5. Emitter
6. Emitter

Caution All four Emitter-pins should be connected to PWB in order to obtain better Electrical performance and heat sinking.

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